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Product Change Notification - JAON-08PTJN759 (Printer Friendly)

Date: 08 Jun 2016
Product Supertex
Category:
Notification subject: CCB 2514 Initial Notice: Qualification of GTK assembly site for selected Supertex products using wafers with Au backside coating available in 3L TO-92 package.
Notification text: **PCN Status:** Initial notification

Microchip Parts Affected:

Please open the attachments found in the attachments field below labeled as PCN_#_Affected_CPN.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

Description of Change:

Qualification of GTK assembly site for selected Supertex products using wafers with Au backside coating available in 3L TO-92 package.

Pre Change:

Assembled at CRTK assembly site

Post Change:

Assembled at GTK assembly site

Pre and Post Change Summary:

	Pre Change	Post Change
Assembly Site	CRTK assembly site	GTK assembly site
Wire material	Au wire	Au wire

Die attach material	84-1 LMISR4	8060T
Molding compound material	EME-G600	G600F
Lead frame material	KFC	A194
Die Thickness	11 mil	11 mil

Impacts to Data Sheet:

None

Reason for Change:

To improve productivity by qualifying GTK assembly site.

Change Implementation Status:

In Progress

Estimated Qualification Completion Date:

Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date.

Summary Table:

	June 2016				
	22	23	24	25	26
WW					
Initial PCN Issue Date		X			
Qual Report Availability			X		
Final PCN Issue Date			X		
Estimated Implementation Date				X	

Markings to Distinguish Revised from Unrevised Devices:

Traceability code

Revision History:

June 8, 2016: Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

Attachment(s): [PCN_JAON-08PTJN759_Qual_Plan.pdf](#)
[PCN_JAON-08PTJN759_Affected_CPN.pdf](#)
[PCN_JAON-08PTJN759_Affected_CPN.xls](#)

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